

YIDONG REN

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428 S. Shaw Lane, East Lansing, MI - 48824, USA

RESEARCH INTERESTS

Internet of Things, Wireless Networking, Low-Power Wide-Area Network, Smart Agriculture

EDUCATION

Michigan State University

East Lansing, USA

Ph.D. Candidate, Department of Computer Science and Engineering

2021 – Present

Advisor: Zhichao Cao

University of Electronic Science and Technology of China

Chengdu, China

B.E., Electronic and Information Engineering

2017 – 2021

CONFERENCE PUBLICATIONS

* denotes equal contribution, _ are students I mentor

First-author papers:

- INFOCOM 2025** [C1] AeroEcho: Towards Agricultural Low-power Wide-area Backscatter with Aerial Excitation Source.
Yidong Ren, Gen Li, Yimeng Liu, Younsuk Dong, Zhichao Cao
IEEE Conference on Computer Communications, 2025
Acceptance ratio: 18.66%
- MobiCom 2024** [C2] SateRIoT: High-performance Ground-Space Networking for Rural IoT.
Yidong Ren, Amalinda Gamage, Li Liu, Mo Li, Shigang Chen, Younsuk Dong, Zhichao Cao.
The 30th Annual International Conference On Mobile Computing And Networking.
Acceptance ratio: 20.85%
- MobiCom 2024** [C3] Demeter: Reliable Cross-soil LPWAN with Low-cost Signal Polarization Alignment.
Yidong Ren, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao Liu, Tianxing Li, Zhichao Cao.
The 30th Annual International Conference On Mobile Computing And Networking.
Acceptance ratio: 20.85%
- MobiSys 2024** [C4] ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT.
Yidong Ren* (co-primary author), Chenning Li*, Shuai Tong, Shakhrol Iman Siam, Mi Zhang, Jiliang Wang, Yunhao Liu, Zhichao Cao.
The 22nd ACM International Conference on Mobile Systems, Applications, and Services
Acceptance ratio: 16.35%
- INFOCOM 2023** [C5] Prism: High-throughput LoRa Backscatter with Non-linear Chirps.
Yidong Ren, Puyu Cai, Jinyan Jiang, Jialuo Du, Zhichao Cao.
IEEE Conference on Computer Communications, 2023
Acceptance ratio: 19.21%
- ICNP 2022** [C6] Is Lorawan Really Wide? Fine-grained LoRa Link-level Measurement in An Urban Environment.
Yidong Ren* (co-primary author), Li Liu*, Chenning Li*, Zhichao Cao and Shigang Chen.
The 30th IEEE International Conference on Network Protocols.
Acceptance ratio: 21.43%
- Other papers:
- SenSys 2025** [C7] Proteus: Enhanced mmWave Leaf Wetness Detection with Cross-Modality Knowledge Transfer.
Yimeng Liu, Maolin Gan, Huaili Zeng, **Yidong Ren**, Gen Li, Jingkai Lin, Younsuk Dong, Xiaobo Tan, Zhichao Cao.
The 23rd ACM Conference on Embedded Networked Sensor Systems.
Acceptance ratio: 18.78%

MobiCom 2024	[C8] LoRaTrimmer: Optimal Energy Condensation with Chirp Trimming for LoRa Weak Signal Decoding. Jialuo Du, Yunhao Liu, Yidong Ren , Li Liu, Zhichao Cao. The 30th Annual International Conference On Mobile Computing And Networking. <i>Acceptance ratio: 20.85%</i>
SenSys 2024	[C9] PiezoBud: A Piezo-Aided Secure Earbud with Practical Speaker Authentication. Gen Li*, Huaili Zeng*, Hanqing Guo, Yidong Ren , Aiden Dixon, Zhichao Cao and Tianxing Li. The 22nd ACM Conference on Embedded Networked Sensor Systems. <i>Acceptance ratio: 18.53%</i>
MobiHoc 2023	[C10] SRLoRa: Neural-enhanced LoRa Weak Signal Decoding with Multi-gateway Super Resolution. Jialuo Du, Yidong Ren , Zhuizhu, Chenning Li, Zhichao Cao, Qiang Ma, Yunhao Liu. The 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for Mobile Networks and Mobile Computing <i>Acceptance ratio: 22.06%</i>

JOURNAL PUBLICATIONS

TMC	[J1] Morph: ChirpTransformer-based Encoder-decoder Co-design for Reliable LoRa Communication. Yidong Ren , Maolin Gan, Mi Zhang, Shigang Chen, Zhichao Cao. <i>Under review of IEEE Transactions on Mobile Computing</i>
TIoT	[J2] NELoRa: Towards Ultra-low SNR LoRa Communication with Neural-enhanced Demodulation. Maolin Gan*, <u>Khang Nguyen*</u> , Jialuo Du, Yidong Ren , Huacheng Zeng, Mi Zhang, Shigang Chen, Zhichao Cao. <i>Under review of ACM Transactions on Internet of Things</i>
TMC	[J3] Channel Adapted Antenna Augmentation for Improved Wi-Fi Throughput. Yanbo Zhang, Weiping Sun, Yidong Ren , Sung-ju Lee, Mo Li. IEEE Transactions on Mobile Computing, 2022.

BENCHMARK

ICLR ML4IoT	NELoRa-Bench: A Benchmark for Neural-enhanced LoRa Demodulation. Jialuo Du, Yidong Ren , Mi Zhang, Yunhao Liu and Zhichao Cao. International Conference on Learning Representations Workshop on Machine Learning for IoT, 2023. Oral
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DEMO

MobiCom 2024	Demeter-Demo: Demonstrating Cross-soil LPWAN with Low-cost Signal Polarization Alignment. Yidong Ren , Yawen Wang, Younsuk Dong, Shigang Chen, Mi Zhang, Jiliang Tang, Zhichao Cao. The 30th Annual International Conference On Mobile Computing And Networking (Demo)
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INTERNSHIP EXPERIENCE

Qualcomm , WLAN System Team. Santa Clara, CA, USA	06/2024 – 09/2024
Research on <i>DNN-assisted Wi-Fi CSI localization</i> and <i>Deep reinforcement learning for Wi-Fi roaming</i> .	
Nanyang Technological University , WADNS Group, Singapore	07/2019 – 10/2019
Channel adaptive Wi-Fi intelligent antenna selection system. Advisor: Mo Li	

TEACHING EXPERIENCE

Michigan State University , Department of Computer Science and Engineering	
Teaching Assistant	
• CSE 220 — Programming in C	Spring 2022, Spring 2023, Spring 2024

ACADEMIC SERVICE

Program Committee of	
• USENIX Security Artifact Evaluation	2025
• ACM MobiCom Artifact Evaluation	2024-2025
• ACM MobiSys Artifact Evaluation	2024
• ACM SenSys Artifact Evaluation	2024

• IEEE International Conference on Parallel and Distributed Systems (ICPADS)	2024
Invited Journal Reviewer of	
• IEEE/ACM Transactions on Networking	2023-2025
• IEEE Transactions on Mobile Computing	2024-2025
• IEEE Transactions on Communication	2025
• IEEE Transactions on Wireless Communication	2025
• IEEE Internet Computing	2025
• ACM Transactions on Sensor Network	2022-2024
Conference Reviewer of	
• IEEE International Symposium on Dynamic Spectrum Access Networks (DySpan)	2022-2023
• EAI MobiQuitous	2022

MENTORSHIP

Puyu Cai	02/2022-12/2022
Now: Master student at Computer Science Department, New York University	
Khang Nguyen, Nam Nguyen	03/2023 - Present
Now: Honor College, Michigan State University	

HONOR AND AWARDS

Dissertation Completion Fellowship, Graduate School at Michigan State University	2025
Distinguished Artifact Reviewer, ACM MobiCom	2024
Student Travel Grant, ACM MobiCom	2024
Student Travel Grant, ACM MobiSys	2024
Student Travel Grant, ACM MobiHoc	2023
Student Travel Grant, IEEE ICNP	2022

GRANTS EXPERIENCE

I assisted in the preparation of proposals for the following research grants:

NSF: LoRa Enabled Space-air-ground Integrated Networks for Next-Generation Agricultural IoT.
Award number 2338976.

NSF: Towards High-Performing LoRa with Embedded Intelligence on the Edge.
Award number 2312674.